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"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

### Applications of "[Embedded - Microcontrollers](#)"

#### Details

|                            |   |
|----------------------------|---|
| Product Status             | Obsolete  |
| Core Processor             | PIC   |
| Core Size                  | 8-Bit   |
| Speed                      | 4MHz  |
| Connectivity               | -   |
| Peripherals                | Brown-out Detect/Reset, POR, WDT  |
| Number of I/O              | 13  |
| Program Memory Size        | 1.75KB (1K x 14)  |
| Program Memory Type        | OTP   |
| EEPROM Size                | 128 x 8   |
| RAM Size                   | 96 x 8  |
| Voltage - Supply (Vcc/Vdd) | 2.5V ~ 5.5V   |
| Data Converters            | -   |
| Oscillator Type            | External  |
| Operating Temperature      | -40°C ~ 125°C (TA)  |
| Mounting Type              | Surface Mount   |
| Package / Case             | 20-SSOP (0.209", 5.30mm Width)  |
| Supplier Device Package    | 20-SSOP   |
| Purchase URL               | <a href="https://www.e-xfl.com/product-detail/microchip-technology/pic16lce624-04e-ss">https://www.e-xfl.com/product-detail/microchip-technology/pic16lce624-04e-ss</a> |

3.1 Clocking Scheme/Instruction Cycle

The clock input (OSC1/CLKIN pin) is internally divided by four to generate four non-overlapping quadrature clocks namely Q1, Q2, Q3 and Q4. Internally, the program counter (PC) is incremented every Q1, the instruction is fetched from the program memory and latched into the instruction register in Q4. The instruction is decoded and executed during the following Q1 through Q4. The clocks and instruction execution flow is shown in Figure 3-2.

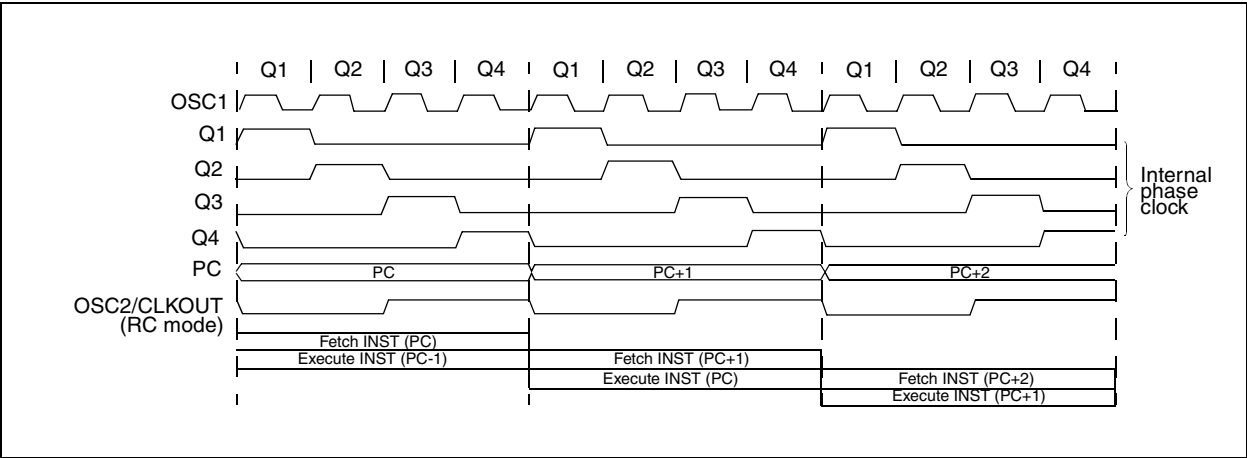
3.2 Instruction Flow/Pipelining

An “Instruction Cycle” consists of four Q cycles (Q1, Q2, Q3 and Q4). The instruction fetch and execute are pipelined such that fetch takes one instruction cycle, while decode and execute takes another instruction cycle. However, due to the pipelining, each instruction effectively executes in one cycle. If an instruction causes the program counter to change (i.e., GOTO) then two cycles are required to complete the instruction (Example 3-1).

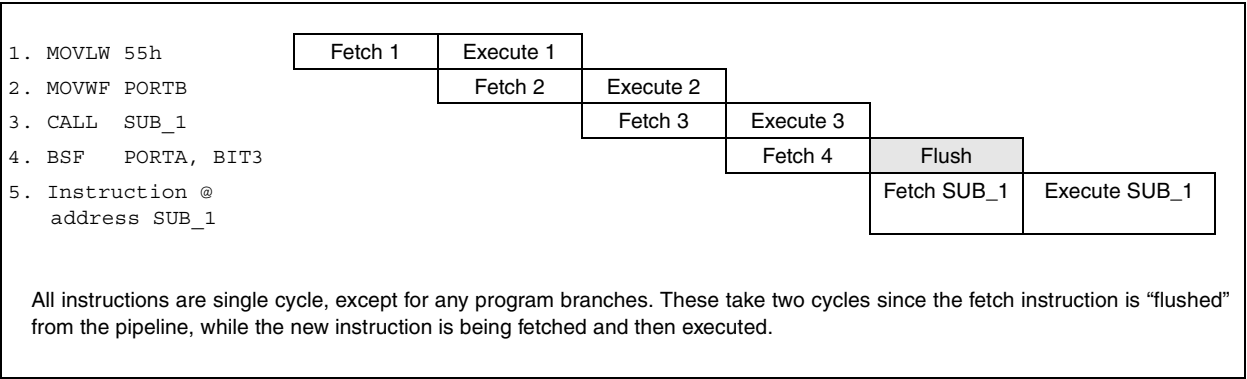
A fetch cycle begins with the program counter (PC) incrementing in Q1.

In the execution cycle, the fetched instruction is latched into the “Instruction Register (IR)” in cycle Q1. This instruction is then decoded and executed during the Q2, Q3, and Q4 cycles. Data memory is read during Q2 (operand read) and written during Q4 (destination write).

FIGURE 3-2: CLOCK/INSTRUCTION CYCLE



EXAMPLE 3-1: INSTRUCTION PIPELINE FLOW



**FIGURE 4-4: DATA MEMORY MAP FOR THE PIC16CE623/624**

| File Address |                          | File Address |                     |
|--------------|--------------------------|--------------|---------------------|
| 00h          | INDF <sup>(1)</sup>      | 80h          | INDF <sup>(1)</sup> |
| 01h          | TMR0                     | 81h          | OPTION              |
| 02h          | PCL                      | 82h          | PCL                 |
| 03h          | STATUS                   | 83h          | STATUS              |
| 04h          | FSR                      | 84h          | FSR                 |
| 05h          | PORTA                    | 85h          | TRISA               |
| 06h          | PORTB                    | 86h          | TRISB               |
| 07h          |                          | 87h          |                     |
| 08h          |                          | 88h          |                     |
| 09h          |                          | 89h          |                     |
| 0Ah          | PCLATH                   | 8Ah          | PCLATH              |
| 0Bh          | INTCON                   | 8Bh          | INTCON              |
| 0Ch          | PIR1                     | 8Ch          | PIE1                |
| 0Dh          |                          | 8Dh          |                     |
| 0Eh          |                          | 8Eh          | PCON                |
| 0Fh          |                          | 8Fh          |                     |
| 10h          |                          | 90h          | EEINTF              |
| 11h          |                          | 91h          |                     |
| 12h          |                          | 92h          |                     |
| 13h          |                          | 93h          |                     |
| 14h          |                          | 94h          |                     |
| 15h          |                          | 95h          |                     |
| 16h          |                          | 96h          |                     |
| 17h          |                          | 97h          |                     |
| 18h          |                          | 98h          |                     |
| 19h          |                          | 99h          |                     |
| 1Ah          |                          | 9Ah          |                     |
| 1Bh          |                          | 9Bh          |                     |
| 1Ch          |                          | 9Ch          |                     |
| 1Dh          |                          | 9Dh          |                     |
| 1Eh          |                          | 9Eh          |                     |
| 1Fh          | CMCON                    | 9Fh          | VRCON               |
| 20h          |                          | A0h          |                     |
|              | General Purpose Register |              |                     |
|              |                          |              |                     |
|              |                          |              |                     |
|              |                          |              |                     |
|              |                          |              |                     |
|              |                          |              |                     |
|              |                          |              |                     |
|              |                          |              |                     |
|              |                          | EFh          |                     |
|              |                          | F0h          | Accesses 70h-7Fh    |
| 7Fh          |                          | FFh          |                     |
|              | Bank 0                   |              | Bank 1              |

Unimplemented data memory locations, read as '0'.  
**Note 1:** Not a physical register.

**FIGURE 4-5: DATA MEMORY MAP FOR THE PIC16CE625**

| File Address |                          | File Address |                     |
|--------------|--------------------------|--------------|---------------------|
| 00h          | INDF <sup>(1)</sup>      | 80h          | INDF <sup>(1)</sup> |
| 01h          | TMR0                     | 81h          | OPTION              |
| 02h          | PCL                      | 82h          | PCL                 |
| 03h          | STATUS                   | 83h          | STATUS              |
| 04h          | FSR                      | 84h          | FSR                 |
| 05h          | PORTA                    | 85h          | TRISA               |
| 06h          | PORTB                    | 86h          | TRISB               |
| 07h          |                          | 87h          |                     |
| 08h          |                          | 88h          |                     |
| 09h          |                          | 89h          |                     |
| 0Ah          | PCLATH                   | 8Ah          | PCLATH              |
| 0Bh          | INTCON                   | 8Bh          | INTCON              |
| 0Ch          | PIR1                     | 8Ch          | PIE1                |
| 0Dh          |                          | 8Dh          |                     |
| 0Eh          |                          | 8Eh          | PCON                |
| 0Fh          |                          | 8Fh          |                     |
| 10h          |                          | 90h          | EEINTF              |
| 11h          |                          | 91h          |                     |
| 12h          |                          | 92h          |                     |
| 13h          |                          | 93h          |                     |
| 14h          |                          | 94h          |                     |
| 15h          |                          | 95h          |                     |
| 16h          |                          | 96h          |                     |
| 17h          |                          | 97h          |                     |
| 18h          |                          | 98h          |                     |
| 19h          |                          | 99h          |                     |
| 1Ah          |                          | 9Ah          |                     |
| 1Bh          |                          | 9Bh          |                     |
| 1Ch          |                          | 9Ch          |                     |
| 1Dh          |                          | 9Dh          |                     |
| 1Eh          |                          | 9Eh          |                     |
| 1Fh          | CMCON                    | 9Fh          | VRCON               |
| 20h          |                          | A0h          |                     |
|              | General Purpose Register |              |                     |
|              |                          |              |                     |
|              |                          |              |                     |
|              |                          |              |                     |
|              |                          |              |                     |
|              |                          |              |                     |
|              |                          |              |                     |
|              |                          |              |                     |
|              |                          | BFh          |                     |
|              |                          | C0h          |                     |
|              |                          | F0h          | Accesses 70h-7Fh    |
| 7Fh          |                          | FFh          |                     |
|              | Bank 0                   |              | Bank 1              |

Unimplemented data memory locations, read as '0'.  
**Note 1:** Not a physical register.

## 4.4 Indirect Addressing, INDF and FSR Registers

The INDF register is not a physical register. Addressing the INDF register will cause indirect addressing.

Indirect addressing is possible by using the INDF register. Any instruction using the INDF register actually accesses data pointed to by the File Select Register (FSR). Reading INDF itself indirectly will produce 00h. Writing to the INDF register indirectly results in a no-operation (although status bits may be affected). An effective 9-bit address is obtained by concatenating the 8-bit FSR register and the IRP bit (STATUS<7>), as shown in Figure 4-7. However, IRP is not used in the PIC16CE62X.

A simple program to clear RAM location 20h-2Fh using indirect addressing is shown in Example 4-1.

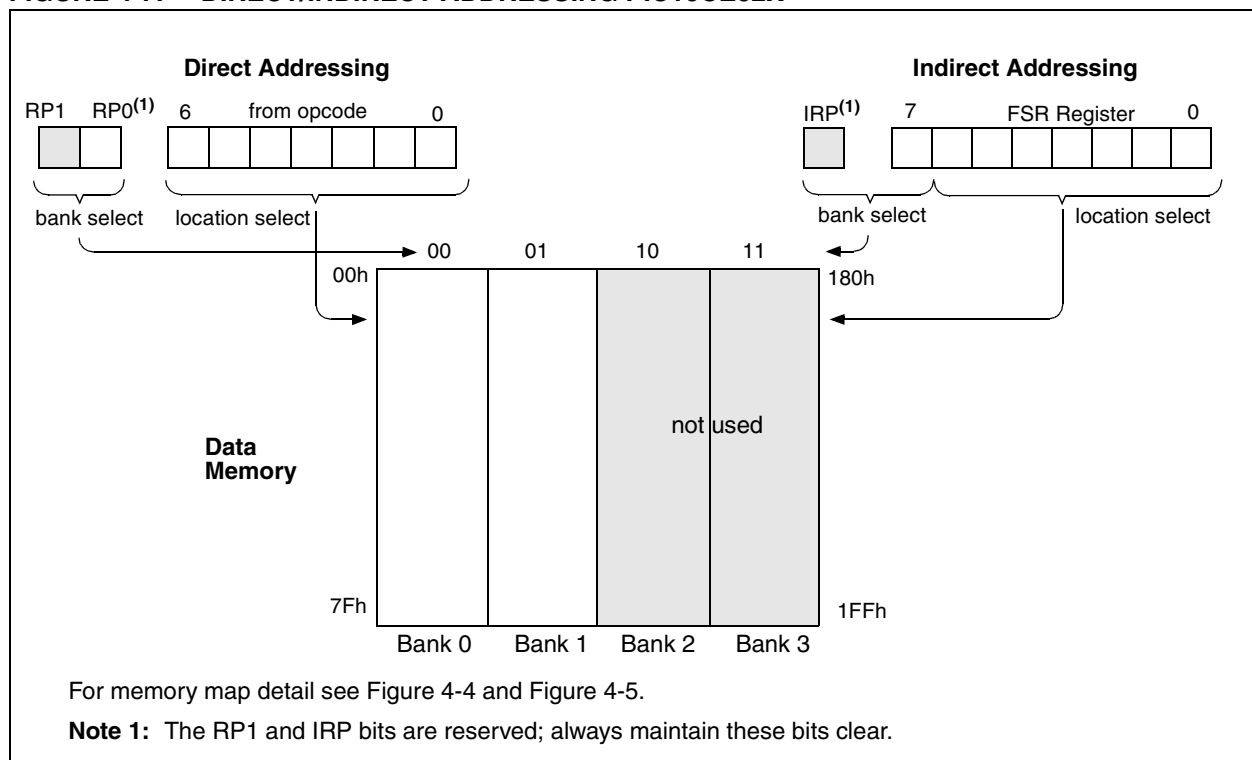
### EXAMPLE 4-1: INDIRECT ADDRESSING

```

movlw 0x20    ;initialize pointer
movwf FSR     ;to RAM
NEXT         clrfs INDF ;clear INDF register
            incf FSR    ;inc pointer
            btfss FSR,4 ;all done?
            goto NEXT   ;no clear next
                        ;yes continue
CONTINUE:

```

FIGURE 4-7: DIRECT/INDIRECT ADDRESSING PIC16CE62X



## 5.2 PORTB and TRISB Registers

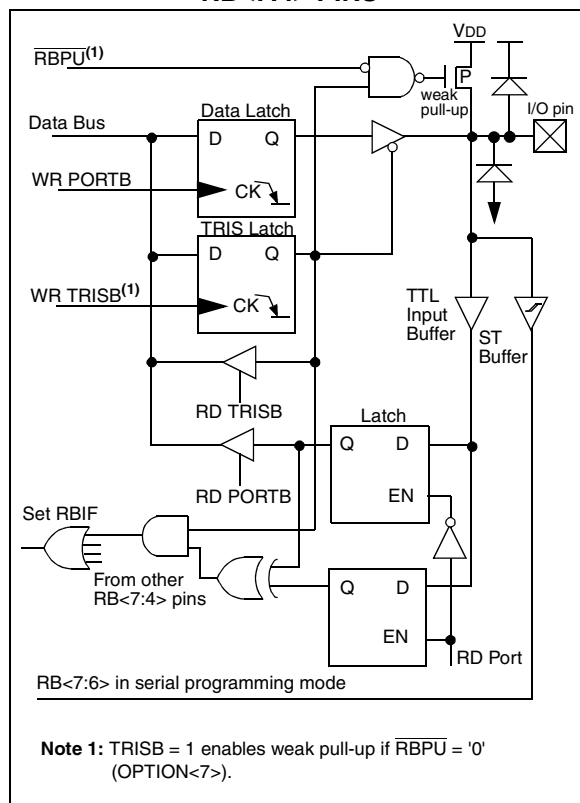
PORTB is an 8-bit wide, bi-directional port. The corresponding data direction register is TRISB. A '1' in the TRISB register puts the corresponding output driver in a high impedance mode. A '0' in the TRISB register puts the contents of the output latch on the selected pin(s).

Reading PORTB register reads the status of the pins, whereas writing to it will write to the port latch. All write operations are read-modify-write operations. So a write to a port implies that the port pins are first read, then this value is modified and written to the port data latch.

Each of the PORTB pins has a weak internal pull-up ( $\approx 200 \mu\text{A}$  typical). A single control bit can turn on all the pull-ups. This is done by clearing the  $\overline{\text{RBPU}}$  (OPTION<7>) bit. The weak pull-up is automatically turned off when the port pin is configured as an output. The pull-ups are disabled on Power-on Reset.

Four of PORTB's pins, RB<7:4>, have an interrupt on change feature. Only pins configured as inputs can cause this interrupt to occur (i.e., any RB<7:4> pin configured as an output is excluded from the interrupt on change comparison). The input pins of RB<7:4> are compared with the old value latched on the last read of PORTB. The "mismatch" outputs of RB<7:4> are OR'ed together to generate the RBIF interrupt (flag latched in INTCON<0>).

**FIGURE 5-5: BLOCK DIAGRAM OF RB<7:4> PINS**



This interrupt can wake the device from SLEEP. The user, in the interrupt service routine, can clear the interrupt in the following manner:

- Any read or write of PORTB. This will end the mismatch condition.
- Clear flag bit RBIF.

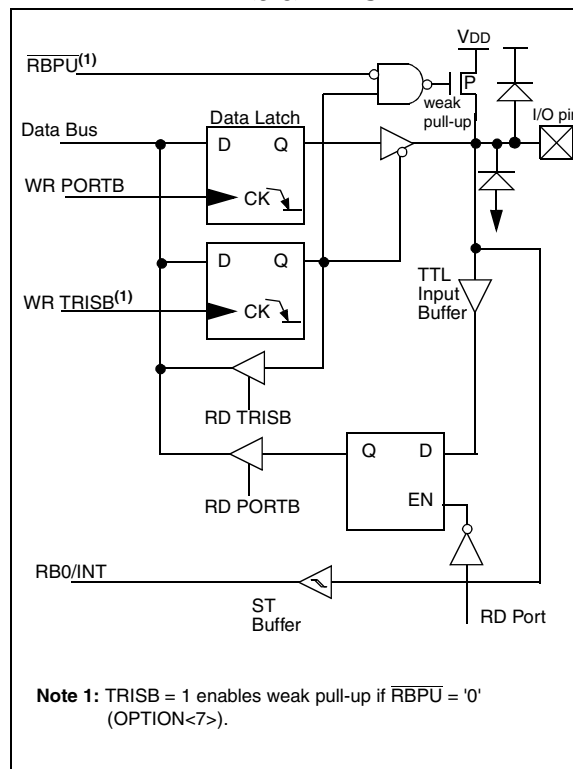
A mismatch condition will continue to set flag bit RBIF. Reading PORTB will end the mismatch condition and allow flag bit RBIF to be cleared.

This interrupt on mismatch feature, together with software configurable pull-ups on these four pins allow easy interface to a key pad and make it possible for wake-up on key-depression. (See AN552, "Implementing Wake-Up on Key Strokes".)

**Note:** If a change on the I/O pin should occur when the read operation is being executed (start of the Q2 cycle), then the RBIF interrupt flag may not get set.

The interrupt on change feature is recommended for wake-up on key depression operation and operations where PORTB is only used for the interrupt on change feature. Polling of PORTB is not recommended while using the interrupt on change feature.

**FIGURE 5-6: BLOCK DIAGRAM OF RB<3:0> PINS**



## 5.3 I/O Programming Considerations

### 5.3.1 BI-DIRECTIONAL I/O PORTS

Any instruction which writes, operates internally as a read followed by a write operation. The BCF and BSF instructions, for example, read the register into the CPU, execute the bit operation and write the result back to the register. Caution must be used when these instructions are applied to a port with both inputs and outputs defined. For example, a BSF operation on bit5 of PORTB will cause all eight bits of PORTB to be read into the CPU. Then the BSF operation takes place on bit5 and PORTB is written to the output latches. If another bit of PORTB is used as a bidirectional I/O pin (i.e., bit0) and it is defined as an input at this time, the input signal present on the pin itself would be read into the CPU and re-written to the data latch of this particular pin, overwriting the previous content. As long as the pin stays in the input mode, no problem occurs. However, if bit0 is switched into output mode later on, the content of the data latch may now be unknown.

Reading the port register, reads the values of the port pins. Writing to the port register writes the value to the port latch. When using read modify write instructions (i.e., BCF, BSF, etc.) on a port, the value of the port pins is read, the desired operation is done to this value, and this value is then written to the port latch.

Example 5-2 shows the effect of two sequential read-modify-write instructions (i.e., BCF, BSF, etc.) on an I/O port.

A pin actively outputting a Low or High should not be driven from external devices at the same time in order to change the level on this pin ("wired-or", "wired-and"). The resulting high output currents may damage the chip.

### EXAMPLE 5-2: READ-MODIFY-WRITE INSTRUCTIONS ON AN I/O PORT

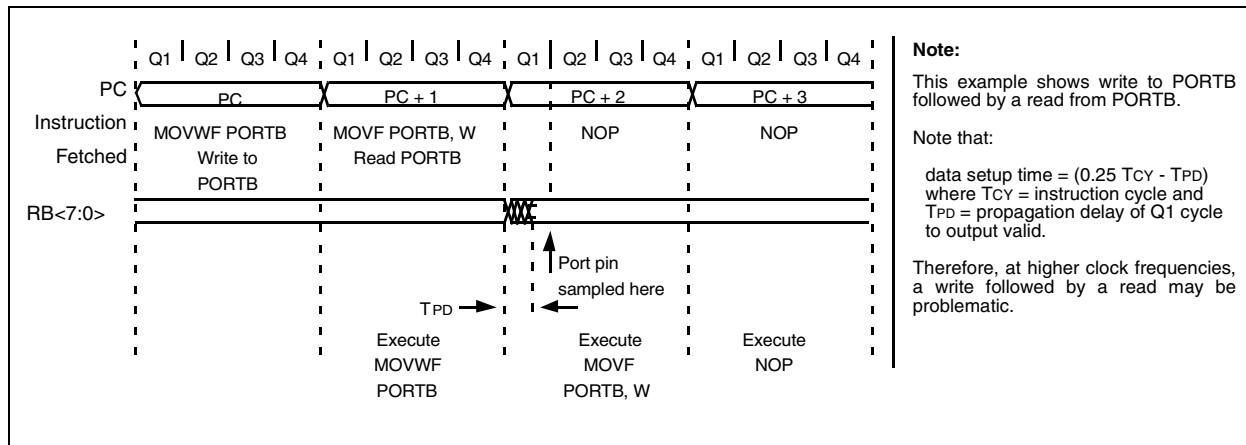
```
; Initial PORT settings:  PORTB<7:4> Inputs
;
;                          PORTB<3:0> Outputs
; PORTB<7:6> have external pull-up and are not
; connected to other circuitry
;
;                          PORT latch  PORT pins
;                          -----  -----

BCF PORTB, 7      ; 01pp pppp   11pp pppp
BCF PORTB, 6      ; 10pp pppp   11pp pppp
BSF STATUS,RP0    ;
BCF TRISB, 7      ; 10pp pppp   11pp pppp
BCF TRISB, 6      ; 10pp pppp   10pp pppp
;
; Note that the user may have expected the pin
; values to be 00pp pppp. The 2nd BCF caused
; RB7 to be latched as the pin value (High).
```

### 5.3.2 SUCCESSIVE OPERATIONS ON I/O PORTS

The actual write to an I/O port happens at the end of an instruction cycle, whereas for reading, the data must be valid at the beginning of the instruction cycle (Figure 5-7). Therefore, care must be exercised if a write followed by a read operation is carried out on the same I/O port. The sequence of instructions should allow the pin voltage to stabilize (load dependent) before the next instruction causes that file to be read into the CPU. Otherwise, the previous state of that pin may be read into the CPU rather than the new state. When in doubt, it is better to separate these instructions with an NOP or another instruction not accessing this I/O port.

**FIGURE 5-7: SUCCESSIVE I/O OPERATION**



## 7.2 Using Timer0 with External Clock

When an external clock input is used for Timer0, it must meet certain requirements. The external clock requirement is due to internal phase clock (TOSC) synchronization. Also, there is a delay in the actual incrementing of Timer0 after synchronization.

### 7.2.1 EXTERNAL CLOCK SYNCHRONIZATION

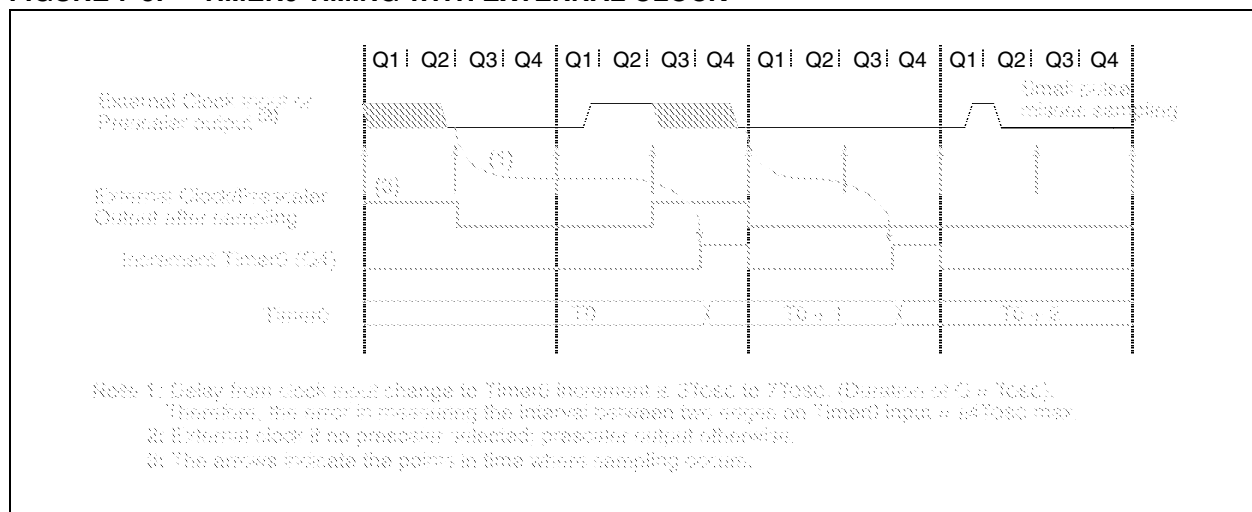
When no prescaler is used, the external clock input is the same as the prescaler output. The synchronization of T0CKI with the internal phase clocks is accomplished by sampling the prescaler output on the Q2 and Q4 cycles of the internal phase clocks (Figure 7-5). Therefore, it is necessary for T0CKI to be high for at least 2TOSC (and a small RC delay of 20 ns) and low for at least 2TOSC (and a small RC delay of 20 ns). Refer to the electrical specification of the desired device.

When a prescaler is used, the external clock input is divided by the asynchronous ripple-counter type prescaler so that the prescaler output is symmetrical. For the external clock to meet the sampling requirement, the ripple-counter must be taken into account. Therefore, it is necessary for T0CKI to have a period of at least 4TOSC (and a small RC delay of 40 ns) divided by the prescaler value. The only requirement on T0CKI high and low time is that they do not violate the minimum pulse width requirement of 10 ns. Refer to parameters 40, 41 and 42 in the electrical specification of the desired device.

### 7.2.2 TIMER0 INCREMENT DELAY

Since the prescaler output is synchronized with the internal clocks, there is a small delay from the time the external clock edge occurs to the time the TMR0 is actually incremented. Figure 7-5 shows the delay from the external clock edge to the timer incrementing.

**FIGURE 7-5: TIMER0 TIMING WITH EXTERNAL CLOCK**



# PIC16CE62X

**TABLE 8-1: REGISTERS ASSOCIATED WITH COMPARATOR MODULE**

| Address | Name   | Bit 7 | Bit 6 | Bit 5 | Bit 4  | Bit 3  | Bit 2  | Bit 1  | Bit 0  | Value on:<br>POR | Value on<br>All Other<br>Resets |
|---------|--------|-------|-------|-------|--------|--------|--------|--------|--------|------------------|---------------------------------|
| 1Fh     | CMCON  | C2OUT | C1OUT | —     | —      | CIS    | CM2    | CM1    | CM0    | 00-- 0000        | 00-- 0000                       |
| 9Fh     | VRCON  | VREN  | VROE  | VRR   | —      | VR3    | VR2    | VR1    | VR0    | 000- 0000        | 000- 0000                       |
| 0Bh     | INTCON | GIE   | PEIE  | T0IE  | INTE   | RBIE   | T0IF   | INTF   | RBIF   | 0000 000x        | 0000 000u                       |
| 0Ch     | PIR1   | —     | CMIF  | —     | —      | —      | —      | —      | —      | -0-- ----        | -0-- ----                       |
| 8Ch     | PIE1   | —     | CMIE  | —     | —      | —      | —      | —      | —      | -0-- ----        | -0-- ----                       |
| 85h     | TRISA  | —     | —     | —     | TRISA4 | TRISA3 | TRISA2 | TRISA1 | TRISA0 | ---1 1111        | ---1 1111                       |

Legend: - = Unimplemented, read as "0", x = Unknown, u = unchanged



## 10.3 Reset

The PIC16CE62X differentiates between various kinds of reset:

- Power-on reset (POR)
- $\overline{\text{MCLR}}$  reset during normal operation
- $\overline{\text{MCLR}}$  reset during SLEEP
- WDT reset (normal operation)
- WDT wake-up (SLEEP)
- Brown-out Reset (BOD)

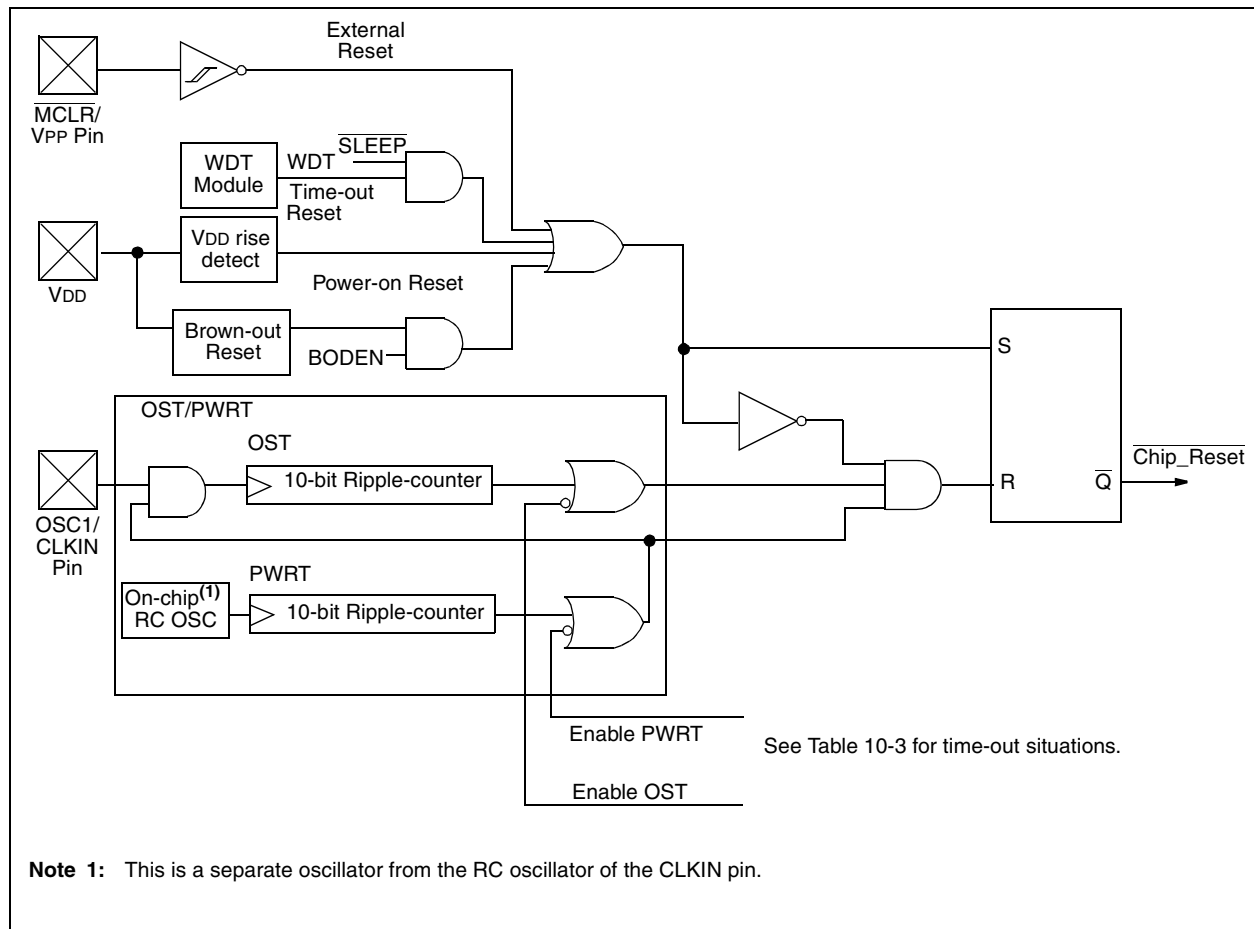
Some registers are not affected in any reset condition. Their status is unknown on POR and unchanged in any other reset. Most other registers are reset to a “reset

state” on Power-on reset,  $\overline{\text{MCLR}}$  reset, WDT reset and  $\overline{\text{MCLR}}$  reset during SLEEP. They are not affected by a WDT wake-up, since this is viewed as the resumption of normal operation.  $\overline{\text{TO}}$  and  $\overline{\text{PD}}$  bits are set or cleared differently in different reset situations as indicated in Table 10-4. These bits are used in software to determine the nature of the reset. See Table 10-6 for a full description of reset states of all registers.

A simplified block diagram of the on-chip reset circuit is shown in Figure 10-6.

The  $\overline{\text{MCLR}}$  reset path has a noise filter to detect and ignore small pulses. See Table 13-5 for pulse width specification.

**FIGURE 10-6: SIMPLIFIED BLOCK DIAGRAM OF ON-CHIP RESET CIRCUIT**



## 10.6 Context Saving During Interrupts

During an interrupt, only the return PC value is saved on the stack. Typically, users may wish to save key registers during an interrupt (i.e. W register and STATUS register). This will have to be implemented in software.

Example 10-1 stores and restores the STATUS and W registers. The user register, W\_TEMP, must be defined in both banks and must be defined at the same offset from the bank base address (i.e., W\_TEMP is defined at 0x70 in Bank 0 and it must also be defined at 0xF0 in Bank 1). The user register, STATUS\_TEMP, must be defined in Bank 0. The Example 10-1:

- Stores the W register
- Stores the STATUS register in Bank 0
- Executes the ISR code
- Restores the STATUS (and bank select bit register)
- Restores the W register

### EXAMPLE 10-1: SAVING THE STATUS AND W REGISTERS IN RAM

```
MOVWF    W_TEMP        ;copy W to temp register,
                        ;could be in either bank

SWAPF    STATUS,W       ;swap status to be saved into W

BCF      STATUS,RP0     ;change to bank 0 regardless
                        ;of current bank

MOVWF    STATUS_TEMP    ;save status to bank 0
                        ;register

:
:   (ISR)
:

SWAPF    STATUS_TEMP,W  ;swap STATUS_TEMP register
                        ;into W, sets bank to original
                        ;state

MOVWF    STATUS         ;move W into STATUS register

SWAPF    W_TEMP,F       ;swap W_TEMP

SWAPF    W_TEMP,W       ;swap W_TEMP into W
```

## 10.7 Watchdog Timer (WDT)

The Watchdog Timer is a free running on-chip RC oscillator which does not require any external components. This RC oscillator is separate from the RC oscillator of the CLKIN pin. That means that the WDT will run, even if the clock on the OSC1 and OSC2 pins of the device have been stopped, for example, by execution of a SLEEP instruction. During normal operation, a WDT time-out generates a device RESET. If the device is in SLEEP mode, a WDT time-out causes the device to wake-up and continue with normal operation. The WDT can be permanently disabled by programming the configuration bit WDTE as clear (Section 10.1).

### 10.7.1 WDT PERIOD

The WDT has a nominal time-out period of 18 ms, (with no prescaler). The time-out periods vary with temperature, VDD and process variations from part to part (see DC specs). If longer time-out periods are desired, a prescaler with a division ratio of up to 1:128 can be assigned to the WDT under software control by writing to the OPTION register. Thus, time-out periods up to 2.3 seconds can be realized.

The CLRWDT and SLEEP instructions clear the WDT and the postscaler, if assigned to the WDT, and prevent it from timing out and generating a device RESET.

The  $\overline{\text{TO}}$  bit in the STATUS register will be cleared upon a Watchdog Timer time-out.

### 10.7.2 WDT PROGRAMMING CONSIDERATIONS

It should also be taken in account that under worst case conditions (VDD = Min., Temperature = Max., max. WDT prescaler), it may take several seconds before a WDT time-out occurs.

## 10.8 Power-Down Mode (SLEEP)

The Power-down mode is entered by executing a SLEEP instruction.

If enabled, the Watchdog Timer will be cleared but keeps running, the  $\overline{PD}$  bit in the STATUS register is cleared, the  $\overline{TO}$  bit is set and the oscillator driver is turned off. The I/O ports maintain the status they had before SLEEP was executed (driving high, low, or hi-impedance).

For lowest current consumption in this mode, all I/O pins should be either at VDD or VSS, with no external circuitry drawing current from the I/O pin, and the comparators and VREF should be disabled. I/O pins that are hi-impedance inputs should be pulled high or low externally to avoid switching currents caused by floating inputs. The T0CKI input should also be at VDD or VSS for lowest current consumption. The contribution from on chip pull-ups on PORTB should be considered.

The  $\overline{MCLR}$  pin must be at a logic high level ( $V_{IHMC}$ ).

**Note:** It should be noted that a RESET generated by a WDT time-out does not drive  $\overline{MCLR}$  pin low.

The first event will cause a device reset. The two latter events are considered a continuation of program execution. The  $\overline{TO}$  and  $\overline{PD}$  bits in the STATUS register can be used to determine the cause of device reset.  $\overline{PD}$  bit, which is set on power-up is cleared when SLEEP is invoked.  $\overline{TO}$  bit is cleared if WDT wake-up occurred.

When the SLEEP instruction is being executed, the next instruction (PC + 1) is pre-fetched. For the device to wake-up through an interrupt event, the corresponding interrupt enable bit must be set (enabled). Wake-up is regardless of the state of the GIE bit. If the GIE bit is clear (disabled), the device continues execution at the instruction after the SLEEP instruction. If the GIE bit is set (enabled), the device executes the instruction after the SLEEP instruction and then branches to the interrupt address (0004h). In cases where the execution of the instruction following SLEEP is not desirable, the user should have an NOP after the SLEEP instruction.

**Note:** If the global interrupts are disabled (GIE is cleared), but any interrupt source has both its interrupt enable bit and the corresponding interrupt flag bits set, the device will immediately wake-up from sleep. The sleep instruction is completely executed.

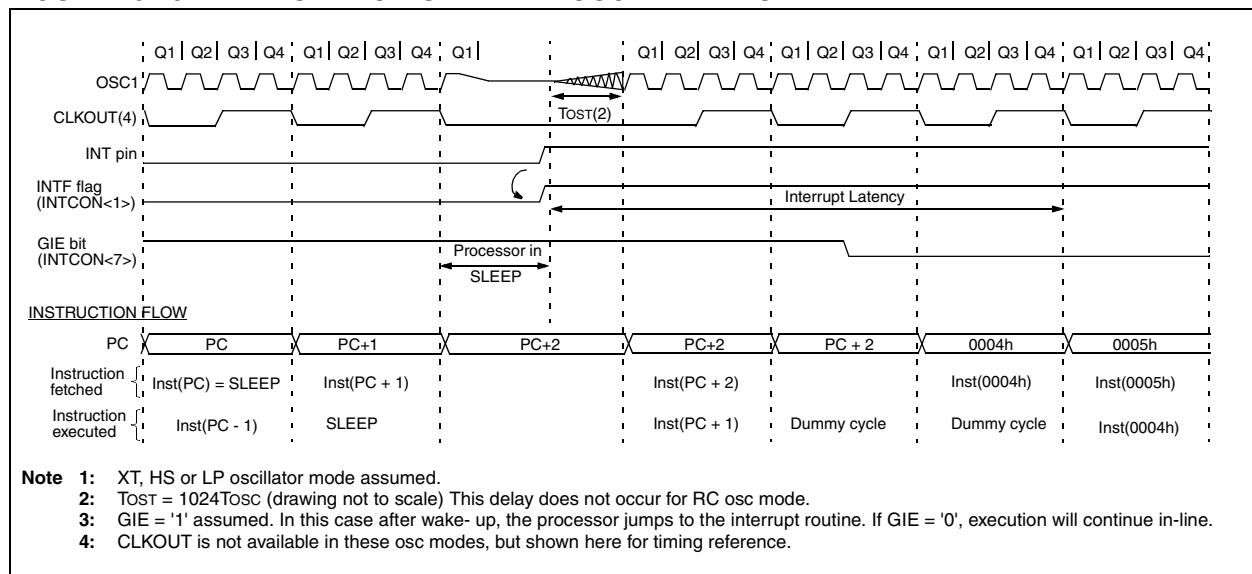
### 10.8.1 WAKE-UP FROM SLEEP

The device can wake-up from SLEEP through one of the following events:

1. External reset input on  $\overline{MCLR}$  pin
2. Watchdog Timer Wake-up (if WDT was enabled)
3. Interrupt from RB0/INT pin, RB Port change, or the Peripheral Interrupt (Comparator).

The WDT is cleared when the device wakes-up from sleep, regardless of the source of wake-up.

**FIGURE 10-19: WAKE-UP FROM SLEEP THROUGH INTERRUPT**



## 11.0 INSTRUCTION SET SUMMARY

Each PIC16CE62X instruction is a 14-bit word divided into an OPCODE which specifies the instruction type and one or more operands which further specify the operation of the instruction. The PIC16CE62X instruction set summary in Table 11-2 lists **byte-oriented**, **bit-oriented**, and **literal and control** operations. Table 11-1 shows the opcode field descriptions.

For **byte-oriented** instructions, 'f' represents a file register designator and 'd' represents a destination designator. The file register designator specifies which file register is to be used by the instruction.

The destination designator specifies where the result of the operation is to be placed. If 'd' is zero, the result is placed in the W register. If 'd' is one, the result is placed in the file register specified in the instruction.

For **bit-oriented** instructions, 'b' represents a bit field designator which selects the number of the bit affected by the operation, while 'f' represents the number of the file in which the bit is located.

For **literal and control** operations, 'k' represents an eight or eleven bit constant or literal value.

**TABLE 11-1: OPCODE FIELD DESCRIPTIONS**

| Field          | Description   |
|----------------|---|
| f              | Register file address (0x00 to 0x7F)  |
| w              | Working register (accumulator)  |
| b              | Bit address within an 8-bit file register   |
| k              | Literal field, constant data or label   |
| x              | Don't care location (= 0 or 1)<br>The assembler will generate code with x = 0. It is the recommended form of use for compatibility with all Microchip software tools. |
| d              | Destination select; d = 0: store result in W,<br>d = 1: store result in file register f.<br>Default is d = 1  |
| label          | Label name  |
| TOS            | Top of Stack  |
| PC             | Program Counter   |
| PCLATH         | Program Counter High Latch  |
| GIE            | Global Interrupt Enable bit   |
| WDT            | Watchdog Timer/Counter  |
| TO             | Time-out bit  |
| PD             | Power-down bit  |
| dest           | Destination either the W register or the specified register file location   |
| [ ]            | Options   |
| ( )            | Contents  |
| →              | Assigned to   |
| < >            | Register bit field  |
| ∈              | In the set of   |
| <i>italics</i> | User defined term (font is courier)   |

The instruction set is highly orthogonal and is grouped into three basic categories:

- **Byte-oriented** operations
- **Bit-oriented** operations
- **Literal and control** operations

All instructions are executed within one single instruction cycle, unless a conditional test is true or the program counter is changed as a result of an instruction. In this case, the execution takes two instruction cycles with the second cycle executed as a NOP. One instruction cycle consists of four oscillator periods. Thus, for an oscillator frequency of 4 MHz, the normal instruction execution time is 1 μs. If a conditional test is true or the program counter is changed as a result of an instruction, the instruction execution time is 2 μs.

Table 11-1 lists the instructions recognized by the MPASM assembler.

Figure 11-1 shows the three general formats that the instructions can have.

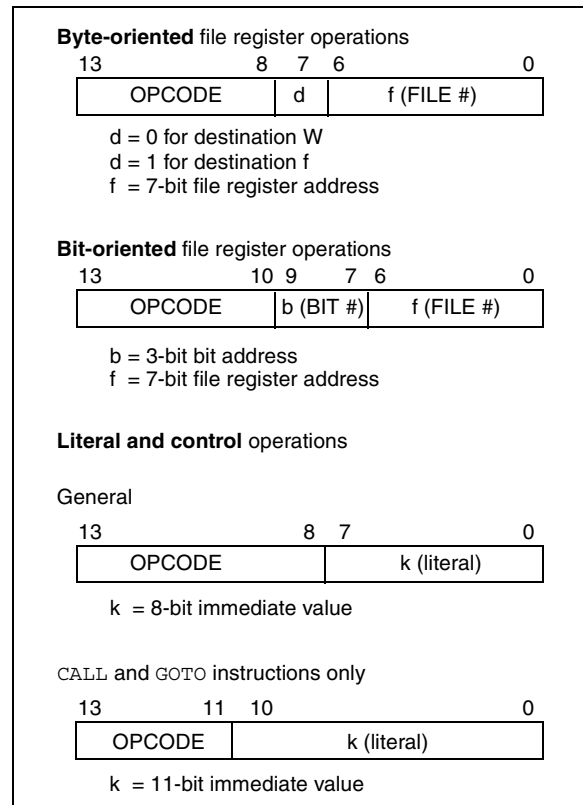
**Note:** To maintain upward compatibility with future PIC® MCU products, do not use the `OPTION` and `TRIS` instructions.

All examples use the following format to represent a hexadecimal number:

0xhh

where h signifies a hexadecimal digit.

**FIGURE 11-1: GENERAL FORMAT FOR INSTRUCTIONS**



## NOP No Operation

Syntax: [ *label* ] NOP

Operands: None

Operation: No operation

Status Affected: None

Encoding: 

|    |      |      |      |
|----|------|------|------|
| 00 | 0000 | 0xx0 | 0000 |
|----|------|------|------|

Description: No operation.

Words: 1

Cycles: 1

Example NOP

## RETFIE Return from Interrupt

Syntax: [ *label* ] RETFIE

Operands: None

Operation: TOS → PC,  
1 → GIE

Status Affected: None

Encoding: 

|    |      |      |      |
|----|------|------|------|
| 00 | 0000 | 0000 | 1001 |
|----|------|------|------|

Description: Return from Interrupt. Stack is POPed and Top of Stack (TOS) is loaded in the PC. Interrupts are enabled by setting Global Interrupt Enable bit, GIE (INTCON<7>). This is a two-cycle instruction.

Words: 1

Cycles: 2

Example RETFIE

After Interrupt

PC = TOS  
GIE = 1

## OPTION Load Option Register

Syntax: [ *label* ] OPTION

Operands: None

Operation: (W) → OPTION

Status Affected: None

Encoding: 

|    |      |      |      |
|----|------|------|------|
| 00 | 0000 | 0110 | 0010 |
|----|------|------|------|

Description: The contents of the W register are loaded in the OPTION register. This instruction is supported for code compatibility with PIC16C5X products. Since OPTION is a readable/writable register, the user can directly address it.

Words: 1

Cycles: 1

Example

**To maintain upward compatibility with future PIC® MCU products, do not use this instruction.**

## RETLW Return with Literal in W

Syntax: [ *label* ] RETLW k

Operands:  $0 \leq k \leq 255$

Operation: k → (W);  
TOS → PC

Status Affected: None

Encoding: 

|    |      |      |      |
|----|------|------|------|
| 11 | 01xx | kkkk | kkkk |
|----|------|------|------|

Description: The W register is loaded with the eight bit literal 'k'. The program counter is loaded from the top of the stack (the return address). This is a two-cycle instruction.

Words: 1

Cycles: 2

Example

```
CALL TABLE      ;W contains table
                  ;offset value
                  ;W now has table
•
value
•
TABLE
•
ADDWF PC          ;W = offset
RETLW k1          ;Begin table
RETLW k2          ;
•
•
•
RETLW kn          ; End of table
```

Before Instruction

W = 0x07

After Instruction

W = value of k8

## RETURN Return from Subroutine

Syntax: [ *label* ] RETURN

Operands: None

Operation: TOS → PC

Status Affected: None

Encoding: 

|    |      |      |      |
|----|------|------|------|
| 00 | 0000 | 0000 | 1000 |
|----|------|------|------|

Description: Return from subroutine. The stack is POPed and the top of the stack (TOS) is loaded into the program counter. This is a two cycle instruction.

Words: 1

Cycles: 2

Example  
RETURN  
After Interrupt  
PC = TOS

## RRF Rotate Right f through Carry

Syntax: [ *label* ] RRF f,d

Operands:  $0 \leq f \leq 127$   
 $d \in [0,1]$

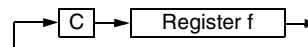
Operation: See description below

Status Affected: C

Encoding: 

|    |      |      |      |
|----|------|------|------|
| 00 | 1100 | dfff | ffff |
|----|------|------|------|

Description: The contents of register 'f' are rotated one bit to the right through the Carry Flag. If 'd' is 0, the result is placed in the W register. If 'd' is 1, the result is placed back in register 'f'.



Words: 1

Cycles: 1

Example RRF REG1, 0

Before Instruction

REG1 = 1110 0110  
C = 0

After Instruction

REG1 = 1110 0110  
W = 0111 0011  
C = 0

## RLF Rotate Left f through Carry

Syntax: [ *label* ] RLF f,d

Operands:  $0 \leq f \leq 127$   
 $d \in [0,1]$

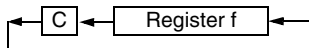
Operation: See description below

Status Affected: C

Encoding: 

|    |      |      |      |
|----|------|------|------|
| 00 | 1101 | dfff | ffff |
|----|------|------|------|

Description: The contents of register 'f' are rotated one bit to the left through the Carry Flag. If 'd' is 0, the result is placed in the W register. If 'd' is 1, the result is stored back in register 'f'.



Words: 1

Cycles: 1

Example RLF REG1, 0  
Before Instruction  
REG1 = 1110 0110  
C = 0  
After Instruction  
REG1 = 1110 0110  
W = 1100 1100  
C = 1

## SLEEP

Syntax: [ *label* ] SLEEP

Operands: None

Operation: 00h → WDT,  
0 → WDT prescaler,  
1 →  $\overline{\text{TO}}$ ,  
0 →  $\overline{\text{PD}}$

Status Affected:  $\overline{\text{TO}}$ ,  $\overline{\text{PD}}$

Encoding: 

|    |      |      |      |
|----|------|------|------|
| 00 | 0000 | 0110 | 0011 |
|----|------|------|------|

Description: The power-down status bit,  $\overline{\text{PD}}$  is cleared. Time-out status bit,  $\overline{\text{TO}}$  is set. Watchdog Timer and its prescaler are cleared. The processor is put into SLEEP mode with the oscillator stopped. See Section 10.8 for more details.

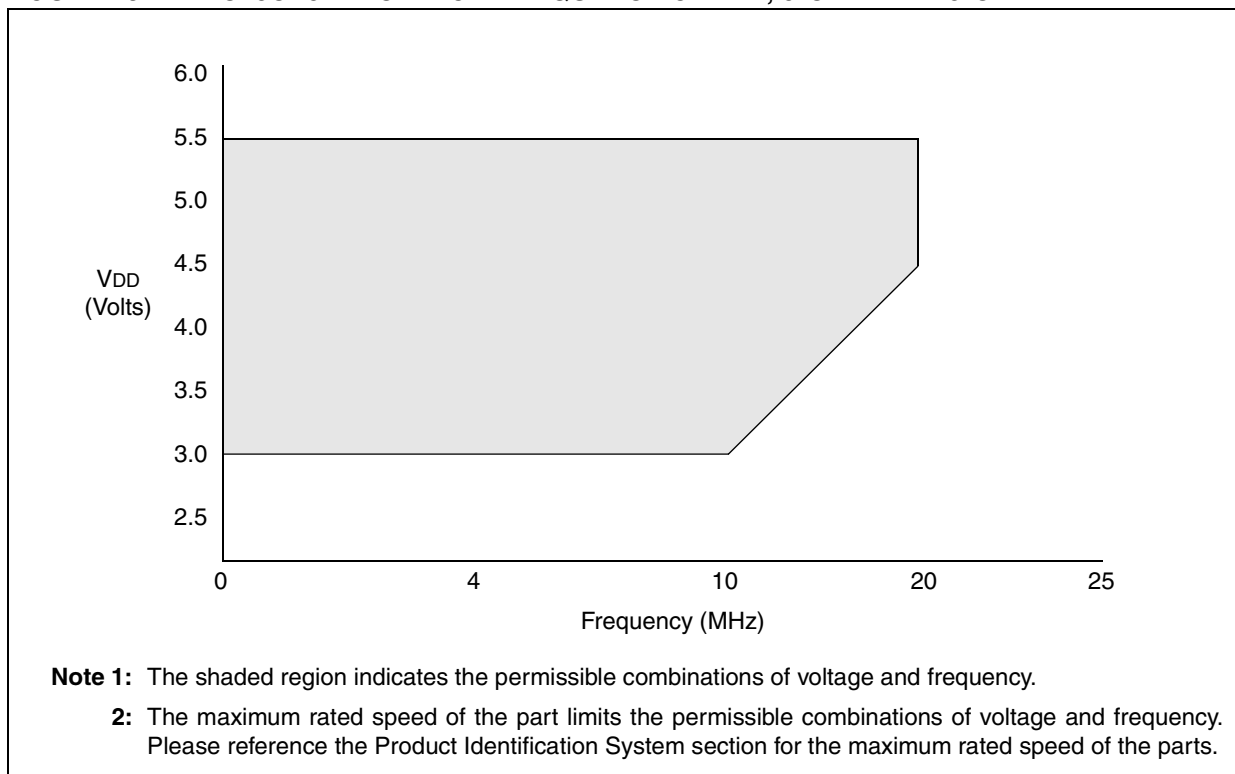
Words: 1

Cycles: 1

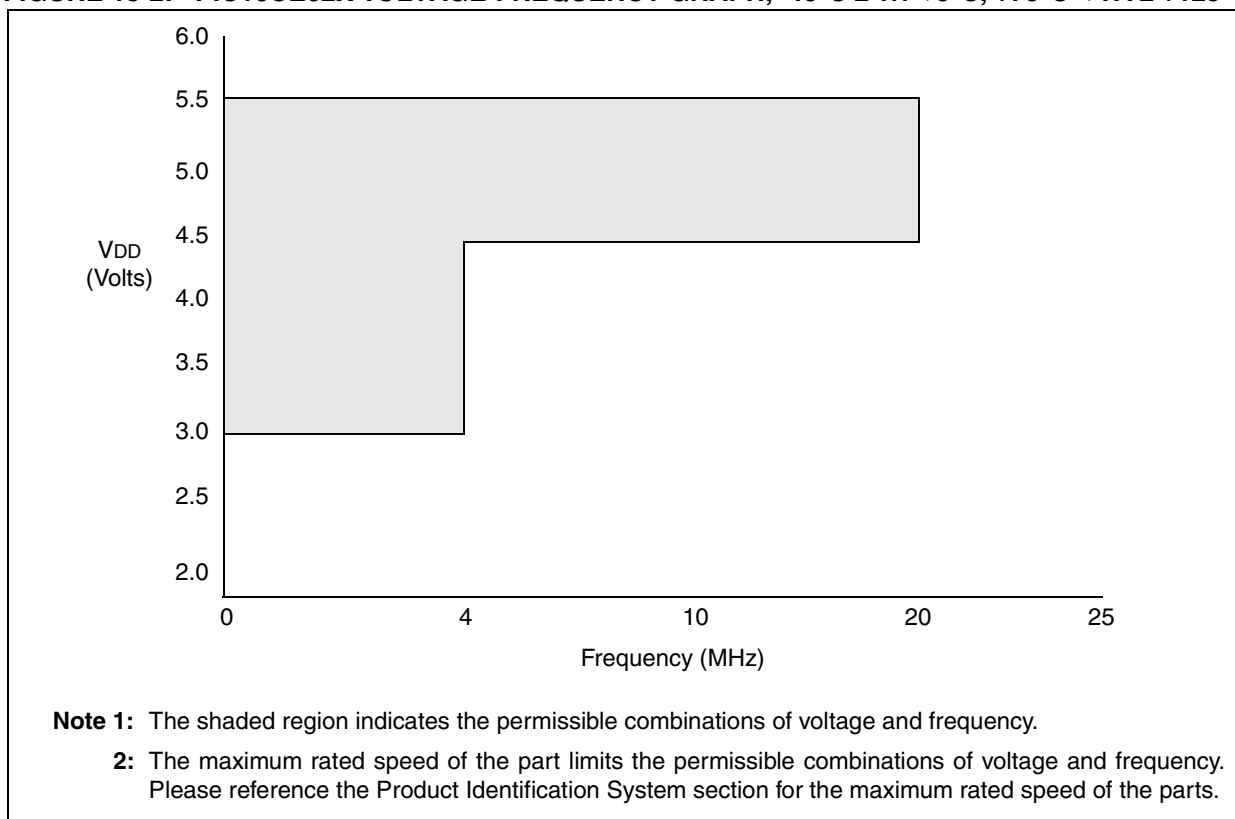
Example: SLEEP

# PIC16CE62X

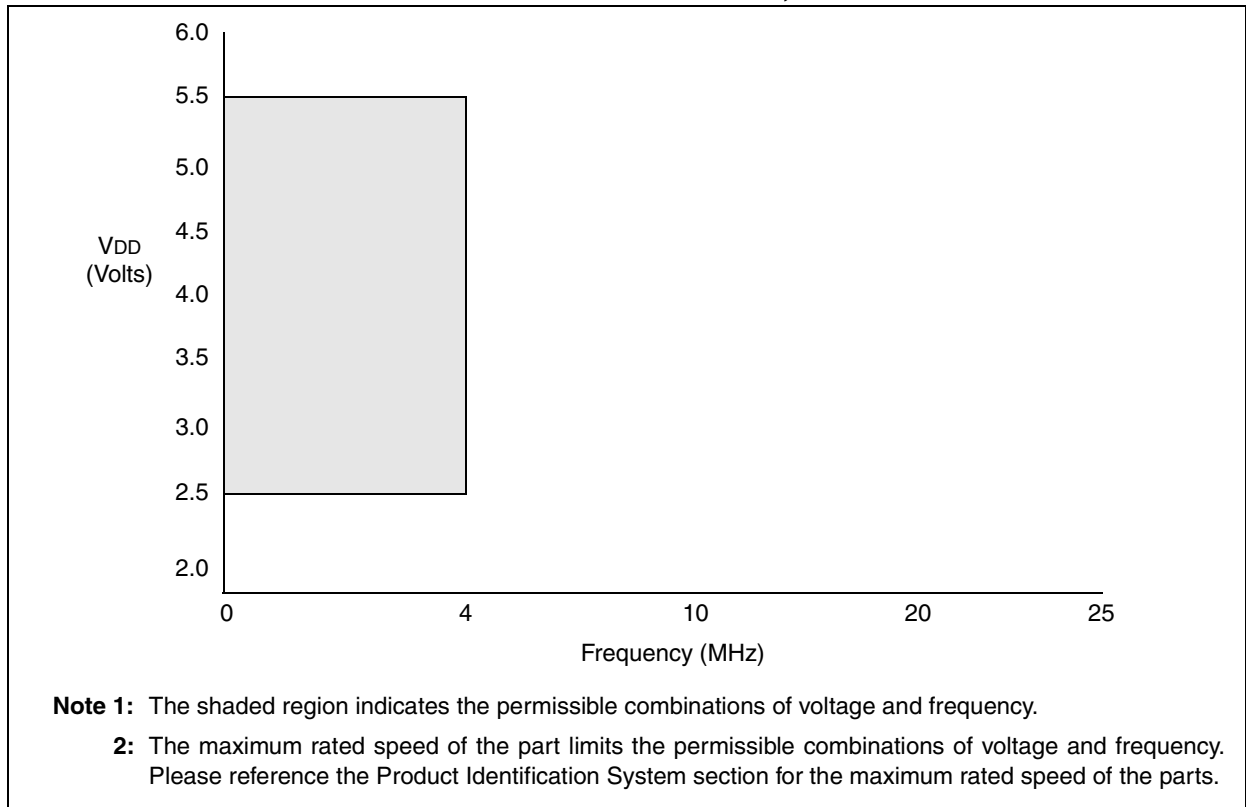
**FIGURE 13-1: PIC16CE62X VOLTAGE-FREQUENCY GRAPH,  $0^{\circ}\text{C} \leq T_A \leq +70^{\circ}\text{C}$**



**FIGURE 13-2: PIC16CE62X VOLTAGE-FREQUENCY GRAPH,  $-40^{\circ}\text{C} \leq T_A < 0^{\circ}\text{C}$ ,  $+70^{\circ}\text{C} < T_A \leq +125^{\circ}\text{C}$**



**FIGURE 13-3: PIC16LCE62X VOLTAGE-FREQUENCY GRAPH,  $-40^{\circ}\text{C} \leq T_A < +125^{\circ}\text{C}$**





# PIC16CE62X

## 13.3 DC CHARACTERISTICS:

**PIC16CE62X-04 (Commercial, Industrial, Extended)**  
**PIC16CE62X-20 (Commercial, Industrial, Extended)**  
**PIC16LCE62X (Commercial, Industrial)**

| DC CHARACTERISTICS |       |  | Standard Operating Conditions (unless otherwise stated)   |      |                 |      |  |
|--------------------|-------|--|---|------|-----------------|------|--|
|                    |       |  | Operating temperature $-40^{\circ}\text{C} \leq \text{TA} \leq +85^{\circ}\text{C}$ for industrial and $0^{\circ}\text{C} \leq \text{TA} \leq +70^{\circ}\text{C}$ for commercial and $-40^{\circ}\text{C} \leq \text{TA} \leq +125^{\circ}\text{C}$ for extended |      |                 |      |  |
|                    |       |  | Operating voltage $\text{VDD}$ range as described in DC spec Table 13-1   |      |                 |      |  |
| Parm No.           | Sym   | Characteristic   | Min   | Typ† | Max             | Unit | Conditions   |
| D030               | VIL   | <b>Input Low Voltage</b><br>I/O ports<br>with TTL buffer                 | VSS   | –    | 0.8V<br>0.15VDD | V    | VDD = 4.5V to 5.5V, Otherwise                                  |
| D031               |       | with Schmitt Trigger input   | VSS   |      | 0.2VDD          | V    |  |
| D032               |       | MCLR, RA4/T0CKI, OSC1 (in RC mode)                                       | VSS   | –    | 0.2VDD          | V    | Note1  |
| D033               |       | OSC1 (in XT and HS)  | VSS   | –    | 0.3VDD          | V    |  |
|                    |       | OSC1 (in LP)   | VSS   | –    | 0.6VDD - 1.0    | V    |  |
| D040               | VIH   | <b>Input High Voltage</b><br>I/O ports<br>with TTL buffer                | 2.0V<br>.25VDD + 0.8V   | –    | VDD<br>VDD      | V    | VDD = 4.5V to 5.5V, Otherwise                                  |
| D041               |       | with Schmitt Trigger input   | 0.8VDD  |      | VDD             | V    |  |
| D042               |       | MCLR RA4/T0CKI   | 0.8VDD  | –    | VDD             | V    |  |
| D043               |       | OSC1 (XT, HS and LP)   | 0.7VDD  | –    | VDD             | V    |  |
| D043A              |       | OSC1 (in RC mode)  | 0.9VDD  |      |                 |      | Note1  |
| D070               | IPURB | PORTB weak pull-up current   | 50  | 200  | 400             | μA   | VDD = 5.0V, VPIN = VSS   |
| D060               | IIL   | <b>Input Leakage Current</b><br>(Notes 2, 3)<br>I/O ports (Except PORTA) | –   | –    | ±1.0            | μA   | VSS ≤ VPIN ≤ VDD, pin at hi-impedance                          |
| D061               |       | PORTA  | –   | –    | ±0.5            | μA   | VSS ≤ VPIN ≤ VDD, pin at hi-impedance                          |
| D063               |       | RA4/T0CKI  | –   | –    | ±1.0            | μA   | VSS ≤ VPIN ≤ VDD   |
|                    |       | OSC1, MCLR   | –   | –    | ±5.0            | μA   | VSS ≤ VPIN ≤ VDD, XT, HS and LP osc configuration              |
| D080               | VOL   | <b>Output Low Voltage</b><br>I/O ports                                   | –   | –    | 0.6             | V    | IOL=8.5 mA, VDD=4.5V, $-40^{\circ}$ to $+85^{\circ}\text{C}$   |
|                    |       |  | –   | –    | 0.6             | V    | IOL=7.0 mA, VDD=4.5V, $+125^{\circ}\text{C}$                   |
| D083               |       | OSC2/CLKOUT (RC only)  | –   | –    | 0.6             | V    | IOL=1.6 mA, VDD=4.5V, $-40^{\circ}$ to $+85^{\circ}\text{C}$   |
|                    |       |  | –   | –    | 0.6             | V    | IOL=1.2 mA, VDD=4.5V, $+125^{\circ}\text{C}$                   |
| D090               | VOH   | <b>Output High Voltage</b> (Note 3)<br>I/O ports (Except RA4)            | VDD-0.7   | –    | –               | V    | IOH=-3.0 mA, VDD=4.5V, $-40^{\circ}$ to $+85^{\circ}\text{C}$  |
|                    |       |  | VDD-0.7   | –    | –               | V    | IOH=-2.5 mA, VDD=4.5V, $+125^{\circ}\text{C}$                  |
| D092               |       | OSC2/CLKOUT (RC only)  | VDD-0.7   | –    | –               | V    | IOH=-1.3 mA, VDD=4.5V, $-40^{\circ}$ to $+85^{\circ}\text{C}$  |
|                    |       |  | VDD-0.7   | –    | –               | V    | IOH=-1.0 mA, VDD=4.5V, $+125^{\circ}\text{C}$                  |
| *D150              | VOD   | <b>Open-Drain High Voltage</b>   |   |      | 8.5             | V    | RA4 pin  |
| D100               | COSC2 | <b>Capacitive Loading Specs on Output Pins</b><br>OSC2 pin               |   |      | 15              | pF   | In XT, HS and LP modes when external clock used to drive OSC1. |
| D101               | Cio   | All I/O pins/OSC2 (in RC mode)   |   |      | 50              | pF   |  |

\* These parameters are characterized but not tested.

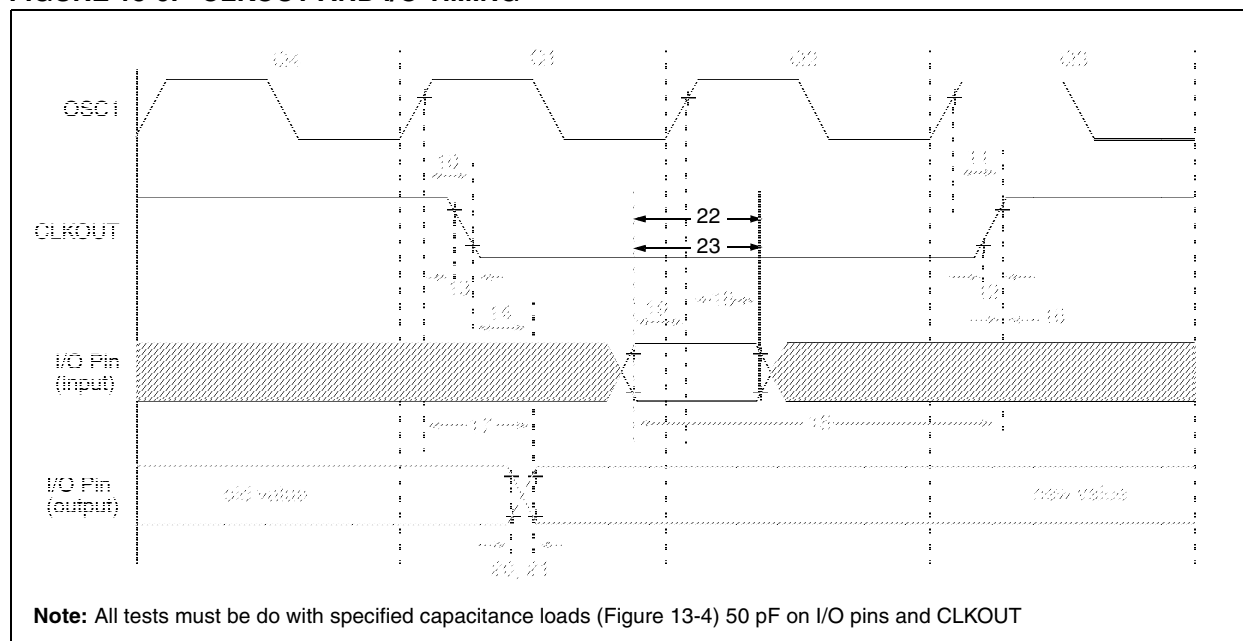
† Data in "Typ" column is at 5.0V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

**Note 1:** In RC oscillator configuration, the OSC1 pin is a Schmitt Trigger input. It is not recommended that the PIC16CE62X be driven with external clock in RC mode.

**2:** The leakage current on the MCLR pin is strongly dependent on applied voltage level. The specified levels represent normal operating conditions. Higher leakage current may be measured at different input voltages.

**3:** Negative current is defined as coming out of the pin.

**FIGURE 13-6: CLKOUT AND I/O TIMING**



**TABLE 13-4: CLKOUT AND I/O TIMING REQUIREMENTS**

| Parameter # | Sym      | Characteristic  | Min          | Typ† | Max | Units |
|-------------|----------|---|--------------|------|-----|-------|
| 10*         | TosH2ckL | OSC1↑ to CLKOUT↓ (1)                                      | —            | 75   | 200 | ns    |
| 11*         | TosH2ckH | OSC1↑ to CLKOUT↑ (1)                                      | —            | 75   | 200 | ns    |
| 12*         | TckR     | CLKOUT rise time (1)                                      | —            | 35   | 100 | ns    |
| 13*         | TckF     | CLKOUT fall time (1)                                      | —            | 35   | 100 | ns    |
| 14*         | TckL2ioV | CLKOUT ↓ to Port out valid (1)                            | —            | —    | 20  | ns    |
| 15*         | TioV2ckH | Port in valid before CLKOUT ↑ (1)                         | Tosc +200 ns | —    | —   | ns    |
| 16*         | TckH2ioI | Port in hold after CLKOUT ↑ (1)                           | 0            | —    | —   | ns    |
| 17*         | TosH2ioV | OSC1↑ (Q1 cycle) to Port out valid                        | —            | 50   | 150 | ns    |
| 18*         | TosH2ioI | OSC1↑ (Q2 cycle) to Port input invalid (I/O in hold time) | 100          | —    | —   | ns    |
| 19*         | TioV2osH | Port input valid to OSC1↑ (I/O in setup time)             | 0            | —    | —   | ns    |
| 20*         | TioR     | Port output rise time                                     | —            | 10   | 40  | ns    |
| 21*         | TioF     | Port output fall time                                     | —            | 10   | 40  | ns    |
| 22*         | Tinp     | RB0/INT pin high or low time                              | 25           | —    | —   | ns    |
| 23          | Trbp     | RB<7:4> change interrupt high or low time                 | Tcy          | —    | —   | ns    |

\* These parameters are characterized but not tested

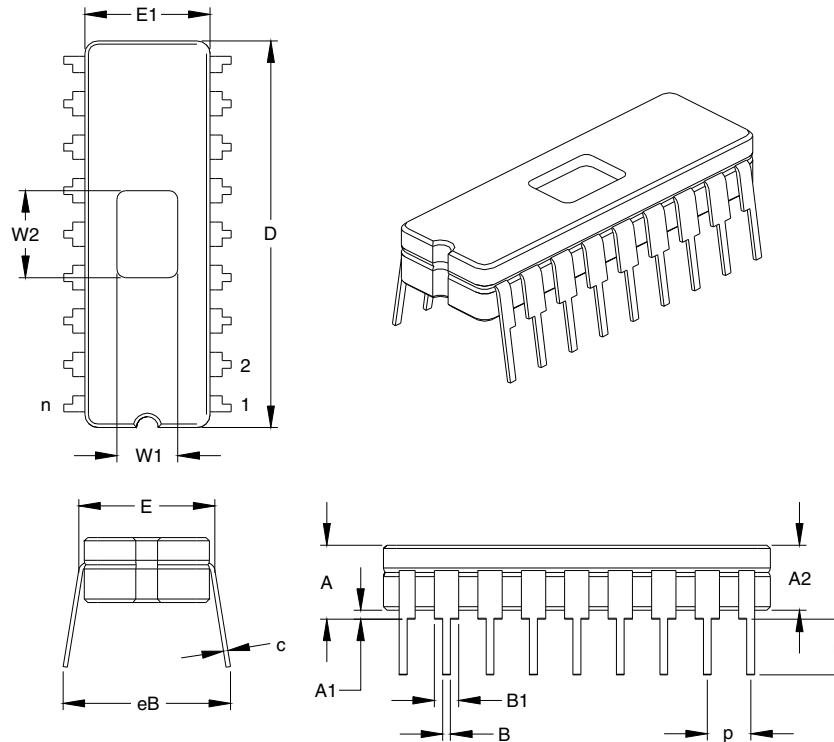
† Data in "Typ" column is at 5.0V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

**Note 1:** Measurements are taken in RC Mode where CLKOUT output is 4 x Tosc.

## 14.0 PACKAGING INFORMATION

### 18-Lead Ceramic Dual In-line with Window (JW) – 300 mil (CERDIP)

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



| Units                      |    | INCHES* |      |      | MILLIMETERS |       |       |
|----------------------------|----|---------|------|------|-------------|-------|-------|
| Dimension Limits           |    | MIN     | NOM  | MAX  | MIN         | NOM   | MAX   |
| Number of Pins             | n  |         | 18   |      |             | 18    |       |
| Pitch                      | p  |         | .100 |      |             | 2.54  |       |
| Top to Seating Plane       | A  | .170    | .183 | .195 | 4.32        | 4.64  | 4.95  |
| Ceramic Package Height     | A2 | .155    | .160 | .165 | 3.94        | 4.06  | 4.19  |
| Standoff                   | A1 | .015    | .023 | .030 | 0.38        | 0.57  | 0.76  |
| Shoulder to Shoulder Width | E  | .300    | .313 | .325 | 7.62        | 7.94  | 8.26  |
| Ceramic Pkg. Width         | E1 | .285    | .290 | .295 | 7.24        | 7.37  | 7.49  |
| Overall Length             | D  | .880    | .900 | .920 | 22.35       | 22.86 | 23.37 |
| Tip to Seating Plane       | L  | .125    | .138 | .150 | 3.18        | 3.49  | 3.81  |
| Lead Thickness             | c  | .008    | .010 | .012 | 0.20        | 0.25  | 0.30  |
| Upper Lead Width           | B1 | .050    | .055 | .060 | 1.27        | 1.40  | 1.52  |
| Lower Lead Width           | B  | .016    | .019 | .021 | 0.41        | 0.47  | 0.53  |
| Overall Row Spacing        | eB | .345    | .385 | .425 | 8.76        | 9.78  | 10.80 |
| Window Width               | W1 | .130    | .140 | .150 | 3.30        | 3.56  | 3.81  |
| Window Length              | W2 | .190    | .200 | .210 | 4.83        | 5.08  | 5.33  |

\*Controlling Parameter  
JEDEC Equivalent: MO-036  
Drawing No. C04-010

# PIC16XXXXXX FAMILY

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Fax: 81-6-6152-9310

#### Japan - Tokyo

Tel: 81-3-6880-3770  
Fax: 81-3-6880-3771

#### Korea - Daegu

Tel: 82-53-744-4301  
Fax: 82-53-744-4302

#### Korea - Seoul

Tel: 82-2-554-7200  
Fax: 82-2-558-5932 or  
82-2-558-5934

#### Malaysia - Kuala Lumpur

Tel: 60-3-6201-9857  
Fax: 60-3-6201-9859

#### Malaysia - Penang

Tel: 60-4-227-8870  
Fax: 60-4-227-4068

#### Philippines - Manila

Tel: 63-2-634-9065  
Fax: 63-2-634-9069

#### Singapore

Tel: 65-6334-8870  
Fax: 65-6334-8850

#### Taiwan - Hsin Chu

Tel: 886-3-5778-366  
Fax: 886-3-5770-955

#### Taiwan - Kaohsiung

Tel: 886-7-213-7828  
Fax: 886-7-330-9305

#### Taiwan - Taipei

Tel: 886-2-2508-8600  
Fax: 886-2-2508-0102

#### Thailand - Bangkok

Tel: 66-2-694-1351  
Fax: 66-2-694-1350

### EUROPE

#### Austria - Wels

Tel: 43-7242-2244-39  
Fax: 43-7242-2244-393

#### Denmark - Copenhagen

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Fax: 45-4485-2829

#### France - Paris

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#### Germany - Munich

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Fax: 49-89-627-144-44

#### Italy - Milan

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#### Netherlands - Drunen

Tel: 31-416-690399  
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#### Spain - Madrid

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#### UK - Wokingham

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